Specifications (As of April, 2012)

AV-HS450 Specifications Power Requirement Mainframe: Control Panel: DC12V±10 % (AC adapter provided), 0.8 A Operating Temperature Operating Humidity Operating Humidity AV-HS410 AV-HS410 AV-HS40 AC 100 V to 240 V, 50 Hz/60 Hz, 88 W AC 100 V to 240 V, 50 Hz/60 Hz, 88 W DC 12 V±10 % (AC adapter provided), 2.0 A O°C to 40 °C (32 °F to 104 °F) Operating Humidity Operating H	AG-HMX100
Power Requirement Mainframe: Control Panel: AC 100 V to 120 V(N)/AC 220 V to 240 V(E), 50 Hz/60 Hz, 120 W DC12 V ±10 % (AC adapter provided), 0.8 A AC 100 V to 240 V, 50 Hz/60 Hz, 88 W DC 12 V ±10 % (AC adapter provided), 2.0 A Operating Temperature 0 °C to 40 °C (32 °F to 104 °F) 0 °C to 40 °C (32 °F to 104 °F) 0 °C to 40 °C (32 °F to 104 °F) Operating Humidity 10 % to 90 % (no condensation) 10 % to 90 % (no condensation) 10 % to 90 % (no condensation)	
Power Requirement Control Panel: DC12V ±10 % (AC adapter provided), 0.8 A AC 100 V to 240 V, 50 Hz/60 Hz, 88 W DC 12V ±10 % (AC adapter provided), 2.0 A Operating Temperature 0 °C to 40 °C (32 °F to 104 °F) 0 °C to 40 °C (32 °F to 104 °F) 0 °C to 40 °C (32 °F to 104 °F) Operating Humidity 10 % to 90 % (no condensation) 10 % to 90 % (no condensation) 10 % to 90 % (no condensation)	
Operating Temperature 0 °C to 40 °C (32 °F to 104 °F) 0 °C to 40 °C (32 °F to 104 °F) 0 °C to 40 °C (32 °F to 104 °F) Operating Humidity 10 % to 90 % (no condensation) 10 % to 90 % (no condensation) 10 % to 90 % (no condensation)	AC 100 V to 240 V, 50 Hz/60 Hz, 60 W
Operating Humidity 10 % to 90 % (no condensation) 10 % to 90 % (no condensation) 10 % to 90 % (no condensation)	
	5 °C to 40 °C (41 °F to 104 °F)
Mainframe: (2RU) 482 mm x 88 mm x 471 mm	10 % to 80 % (no condensation)
Dimensions (W x H x D) Control Panel: (19 inches x 3-7/16 inches x 18-9/16 inches) (excluding protrusions) (22-1/16 inches x 3-7/16 inches x 11-3/4 inches) (excluding protrusions) (22-1/16 inches x 3-7/16 inches x 11-3/4 inches) (excluding protrusions) (40 mm x 158 mm x 361 mm (17-5/16 inches x 6-7/32 inches x 14-7/32 inches) (excluding protrusions) (8-1/4 inches x 2-5/8 inches x 6-15/16 inches) (excluding protrusions)	424 mm x 197 mm x 400 mm (16-3/4 inches x 7-3/4 inches x 15-3/4 inches) (excluding protrusions)
Weight Approx. 9.8 kg (21.6 lb) (without options/excluding accessories) Approx. 10.3 kg (22.7 lb) (with full options/excluding accessories) Approx. 3.9 kg (8.6 lb) (excluding accessories) Approx. 3.9 kg (8.6 lb) (excluding accessories) Approx. 6.6 kg (14.550 lb) e (with full options/excluding accessories) Approx. 6.8 kg (13.669 lb) (without options/excluding accessories) Approx. 1.4 kg (3.1 lb) (without options)	Approx. 7.9 kg (17.4 lbs) (without options)
HD: 1080/59.94i, 1080/50i, 1080/24PsF*1, 1080/23.98PsF*1, 1080/23.98PsF*1, 1080/23.98PsF*1, 1080/23.98PsF*1, 1080/23.98PsF*2,	/59.94p, 720/50p HD: 1080/23.98PsF (for 3D only), 1080/59.94i, 1080/50i, 720/59.94p, 720/50p 480/59.94i, 576/50i *Mixed operation of different video formats is not possible.
Video Processing Y:CB:CR 4:2:2, 10 bit (8 bit for FMEM) / RGB 4:4:4, 8 bit Y:CB:CR 4:2:2, 10 bit (8 bit for FMEM) / RGB 4:4:4, 8 bit Y:CB:CR 4:2:2, 10 bit (8 bit for FMEM) / RGB 4:4:4, 8 bit	Y:Ps:Pr:Key 4:2:2:4, 12 bit (Internal process)
ME 1ME 1ME 1ME 1ME 1ME	1ME
Wideo Input*3 Video Input*3 V	VIDEO: 2 lines, BNC x 2, Analog Composite, 1.0 V[p-p] (75 Ω) SDI: 4 lines, BNC x 4 HD (SMPTE292M/296M/299M) /SD (SMPTE259M-C/272M-A, ITU-R. BT.656-4) standard HDMI: 2 signal lines, HDMI x 2 (Type A connector), incompatible with HDCP Link and VIERA Link DVI-I: TMDS single link (incompatible with HDCP), compatible with digital/analog RGB
Mainframe, A maximum of 10 outputs Standard SDI: 4 lines, BNC x 5 (OUT 1 to 4 x each, 2 output distribution for OUT 1) HD (SMPTE292M)/SD (SMPTE259M) standard, 0.8 V [p-p] ±10 % (75 Ω) Video Output*3 Video Output*3 Video Output*3 Standard DVI-D: 2 lines, DVI-D x 2, (OUT 5, 6) Optional: Maximum of 10 outputs Standard SDI: 5 lines, BNC x 6 (OUT 1 to 5 x each, 2 output distribution for OUT 1) HD (SMPTE292M)/SD (SMPTE259M) standard, 0.8 V [p-p] ±10 % (75 Ω) Standard DVI-D: 1 line, DVI-D x 1 (Analog output signals are not supported) Optional: Maximum of 12 outputs Optional: Maximum of 10 outputs Standard SDI: 5 lines, BNC x 6 (OUT 1 to 5 x each, 2 output distribution for OUT 1) HD (SMPTE292M)/SD (SMPTE259M) standard, 0.8 V [p-p] ±10 % (75 Ω) Video Output*3 Optional: Maximum of 10 outputs Standard SDI: 5 lines, BNC x 6 (OUT 1 to 5 x each, 2 output distribution for OUT 1) HD (SMPTE292M)/SD (SMPTE259M) standard, 0.8 V [p-p] ±10 % (75 Ω) Optional: Maximum of 4 outputs (OUT A1, A2, B1, B2) Optional: Maximum of 4 outputs (OUT A1, A2, B1, B2) (Up to 2 optional boards may be inserted into the 2 input/ output optional slots) DVI-D: 1 signal line, DVI-D x 1 (Analog output signals are not output optional slots)	SDI: 4 lines, BNC x 4 (PGM/PVW/AUX/MULTIVIEW x each) HD (SMPTE292M/296M/299M) /SD (SMPTE259M-C/272M-A, ITU-R. BT.656-4) standard DVI-D: 2 lines, DVI-D x 2 (PGM/MULTIVIEW x each) TMDS single link (not compatible with HDCP)
Mainframe GENLOCK mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst output signals x 2 Reference Input/Output Reference Input/Output Reference Input/Output Reference Input/Output Same field frequencies as those of the system formats supported. With the 1080/23.98PSF, 1080/24.9FS format, poly SENLOCK mode supported. With the 1080/23.98PSF, 1080/24.9FS format, black burst with 10F-ID (SMPTE318M standard met) or TRI signals supported. Mainframe GENLOCK mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst output signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Slack burst output signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync input signals (with loop-through) Internal sync mode: Black burst or Tri-level Sync mode: Black burst or	External reference (G/L) input: BNC x 2 (with loop-through), 1.0 V [p-p] (75 Ω), Analog composite (NTSC/PAL) Advanced reference (ADV-REF) output: BNC x 1, 75 Ω, Analog composite Sync: 0.286 V [p-p] (NTSC)/0.3 V [p-p] (PAL) Burst: 0.286 V [p-p] (NTSC)/0.3 V [p-p] (PAL)
Audio Input/Output — — — —	AUDIO input: XLR: 4 lines (L and R), +4/0/−3 dBm switchable, balanced, 600 Ω SDI (embedded audio): 4 lines, IH (5MPTE292M/296M/299M)/5D (SMPTE259M-C/272M-A, ITU-R BT.656-4) standard HDMI (embedded audio): 2 lines, Type A connector (not compatible with HDCP) AUX input: Pin jack: 1 line (L and R), −10 dBV, High impedance, unbalanced MIC input: M6 x 1 line, −60 dBV, 2 kΩ, monaural, unbalanced audio): A line (L and R), −10 dBV, Low impedance, balanced PGM/PVW/AUX OUT: SDI (Embedded Audio) x 1, HD (SMPTE292M/296M/299M)/SD (SMPTE259M-C/272M-A, ITU-R BT.656-4) standard PHONES output: M6 x 1, 8 Ω, stereo, unbalanced, −∞ dBu to −20 dBu
PANEL/MAINFRAME RJ45 x 1, 100 Mbps (to connect between the mainframe and the control panel) — — — —	_
EDITOR Mainframe, D-sub 9 pin x 1, RS-422 (GVG protocol compatible) DD-sub 9 pin x 1, RS-422 —	-
EDITOR Mainframe, D-sub 9 pin x 1, RS-422 (GVG protocol compatible) DD-sub 9 pin x 1, RS-422 D-sub 9 pin x 1, RS-4	D-sub 9 pin x 1, R5-232C TALLY output: D sub 9 pin x 1, 8 Cross point Open collector Maximum currents less than 50 mA
Interface COM Mainframe, D-sub 9 pin x 1, RS-422 (pan-tilt system control) D-sub 9 pin x 1, RS-422 (pan-tilt system	D-sub 9 pin x 1, RS-232C TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact
COM Mainframe, D-sub 9 pin x 1, RS-422 (pan-tilt system control) TALLY/GPI Mainframe: D-sub 50 pin x 1 (8 IN, 31 OUT and 1 ALARN OUT may be set) LAN Mainframe, RJ45 x 1, 10 BASE-T/100 BASE-TX D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 9 pin x 1, RS-422 D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output) RJ45, 10 BASE-T/100 BASE-TX RJ45, 10 BASE-T/100 BASE-TX	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC
COM Mainframe, D-sub 9 pin x 1, RS-422 (pan-tilt system control) D-sub 9 pin x 1, RS-422 D-sub 15 pin x 1, RS-422 D-sub	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC
COM Mainframe, D-sub 9 pin x 1, RS-422 (pan-tilt system control) TALLY/GPI Mainframe: Control Panel: D-sub 50 pin x 1, RS-422 (pan-tilt system control) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output) Removable Media Supported by the control panel, Capacity: Maximum 32 GB (SDHC Memory Card compatible) Still image file/movie clip file/shot memory/event memory: Loading/saving, Setup data: backup CD-ROM (Operating instructions / Image transmission software), AC adapter (for control panel), Power cable (for mainframe and AC adapter), Power cable (2 m (6.6 feet) long) CD-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operatin	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact
COM Mainframe, D-sub 9 pin x 1, RS-422 (pan-tilt system control) D-sub 9 pin x 1, RS-422 D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output)	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable)
COM Mainframe, D-sub 9 pin x 1, RS-422 (pan-tilt system control) TALLY/GPI Mainframe: Control Panel: D-sub 50 pin x 1, RS-422 (pan-tilt system control) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output) Removable Media Supported by the control panel, Capacity: Maximum 32 GB (SDHC Memory Card compatible) Still image file/movie clip file/shot memory/event memory: Loading/saving, Setup data: backup CD-ROM (Operating instructions / Image transmission software), AC adapter (for control panel), Power cable (for mainframe and AC adapter), Power cable (2 m (6.6 feet) long) CD-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operating instructions / Image transmission software), AC adapter (D-ROM (Operatin	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7,
COM Mainframe, D-sub 9 pin x 1, RS-422 (pan-tilt system control) TALLY/GPI TALLY/GPI Mainframe: D-sub 50 pin x 1 (8 lN, 31 OUT and 1 ALARN OUT may be set) D-sub 15 pin x 2 (lN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (lN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output) LAN Mainframe, RJ45 x 1, 10 BASE-T/100 BASE-TX Removable Media SD Memory Card Media SD Memory Card Media SD Memory Card CD-ROM (Operating instructions / Image transmission software), AC adapter (for control panel), Power cable (STP, straight cable, 10 m (32.8 feet) long) Function D-sub 9 pin x 1, RS-422 D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output) D-sub 15 pin x 1, RS-422 D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output) D-sub 15 pin x 1, RS-422 D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output) Russinum 32 GB (SDHC Memory Card compatible) Still image file/movie clip file/shot memory/event memory: Loading/saving, Setup data: backup CD-ROM (Operating instructions / Image transmission software), AC adapter (for control panel), Power cable (for mainframe and AC adapter), CD-ROM (Operating instructions/DVI input level adjustment file), Power cable (2 m (6.6 feet) long) CD-ROM (Operating instructions / Image transmission software), AC adapter (power cable (2 m (6.6 feet) long)	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable)
COM Mainframe, D-sub 9 pin x 1, RS-422 [pan-tilt system control] D-sub 9 pin x 1, RS-422 TALLY/GPI Mainframe: Control Panel: D-sub 50 pin x 1 (8 IN, 31 OUT and 1 ALARN OUT may be set) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output) Removable Media SD Memory Card Supported by the control panel; Capacity: Maximum 32 GB (SDHC Memory Card compatible) Still image file/movie clip file/shot memory/event memory: Loading/saving, Setup data: backup Stud pata: CD-ROM (Operating instructions / Image transmission software), AC adapter (for control panel), Power cable (STP, straight cable, 10 m (32.8 feet) long) Function Wipe // DVE Pattern Wipe x 12, Squeeze x 11, Silde x 8, 3D x 12, 2ch squeeze x 4, 2ch slide x 4, 2ch 3D x 4 Wipe x 16, Squeeze x 16, Silde x 8, 3D x 12 Cut, Mix, Wipe (including DVE) Image Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Paint D-sub 9 pin x 1, RS-422 D-sub 9 pin x 1, RS-422 D-sub 9 pin x 1, RS-422 D-sub 15 pin x 1 (8 IN, 31 OUT and 1 ALARN OUT 1) D-sub 15 pin x 1 (8 IN, 31 OUT and 1 ALARN OUT 1) D-sub 15 pin x 1 (8 IN, 31 OUT and 1 ALARN OUT 1) D-sub 15 pin x 1 (8 IN, 31 OUT and 1 ALARN OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) RA45, 10 BASE-T/100 BASE-TX RJ45, 10 BASE-T/100 BASE-TY RJ45, 10 BASE-T/100 BASE-TY RJ45, 10 BASE-T/100 BASE-TY	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8
Interface COM Mainframe, D-sub 9 pin x 1, RS-422 (pan-tilt system control) D-sub 9 pin x 1, RS-422 (pan-tilt system control) D-sub 9 pin x 1, RS-422 (pan-tilt system control) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 1, GPI INPUT x 5 channels (photocoupler sensing), GPI OUTPUT x 7 channels (open collector output) LAN Mainframe, RJ45 x 1, 10 BASE-T/100 BASE-TX Removable Media SD Memory Card Supported by the control panel, Gapacity: Maximum 32 GB (SDHC Memory Card compatible) Still image file: Loading/saving, setup data: backup Standard Accessories CD-ROM (Operating instructions / Image transmission software), AC adapter (for control panel, Power cable (for mainframe and AC adapter), AC adapter (for control panel, Power cable (for mainframe and AC adapter), Power cable (2 m (6.6 feet) long) Wijpe/DVE Pattern Wijpe x 12, Squeeze x 11, Slide x 8, 3D x 12, 2ch squeeze x 4, 2ch slide x 4, 2ch 3D x 4 Wipe x 16, Squeeze x 16, Slide x 8, 3D x 12 Cut, Mix, Wipe (including DVE) Image Mumber of Keys 1 D-sub 15 pin x 1, RS-422 D-sub 15 pin x 1, RS-	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1
Interface COM	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key
Interface COM Mainframe, D-sub 9 pin x 1, RS-422 (pan-tilt system control) D-sub 9 pin x 1, RS-422 D-sub 50 pin x 1 (8 IN, 31 OUT and 1 ALARN OUT may be set)	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE)
Interface COM	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key
Interface COM	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE)
COM Mainframe, D-sub 9 pin x 1, R5-422 (pan-tilt system control) D-sub 9 pin x 1, R5-422 D-sub 15 pin x 2, R5-422 D-sub 15 pin x 3, GP INPUT x 5 channels (photocoupler sensing), Control Panel, D-sub 55 pin x 1, GP INPUT x 5 channels (photocoupler sensing), CP CONTROL Panel, Control Panel, Supported by the C	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 1
COM Mainfame, D-sub 9 pin x 1, RS-422 (pan-tilt system control) D-sub 9 pin x 1, RS-422 —	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 1 Luminance key Mix I
COM	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 1 Luminance key
COM Mainframe, D-sub 9 pin x 1, RS-422 (pan-tilt system control) D-sub 9 pin x 1, RS-422 Control Panel: D-sub 5 pin x 18 IN, 31 OUT and 1 ALARN OUT may be set) D-sub 15 pin x 2 (IN 8, OUT 19, ALARM OUT 1) D-sub 15 pin x 1, GPI (INPUT x 5 channels (photocopyler sensing), GPI OUTPUT x 2 channels (photocop	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 1 Luminance key Mix 1 Mix — Mix —
COM	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 1 Luminance key Mix I
The terface	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 1 Luminance key Mix 1 Mix — SDI-IN 1 to 4, DVI-I IN, HDMI 1 to 2/Composite video 1 to 2
CM	TALLY output: One of pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC Open BNC x 1, Make-Contact One of pin structions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULT1) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror I Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 I Luminance key Mix I Mix — SDI-IN 1 to 4, DVI-I IN, HDMI 1 to 2/Composite video 1 to 2 SDI-IN 1 to 4, DVI-I IN, HDMI 1 to 2/Composite video 1 to 2 — —
Mode Mainframe, D-sub 9 pin x 1, 85-422 (pan-till system control) D-sub 9 pin x 1, 85-422 (pan-till system control) D-sub 15 pin x 2, 90 km, 20 km,	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC PINE BNC x 1, Make-Contact CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 1 Luminance key Mix 1 Mix — SDI-IN 1 to 4, DVI-I IN, HDMI 1 to 2/Composite video 1 to 2 SDI-IN 1 to 4, DVI-I IN, HDMI 1 to 2/Composite video 1 to 2 Every A/B bus
COM. Nainframe, C-bub 9 pin x 1, 18-42 gand stystem control D-sub 9 pin x 1, 18-42 gand stystem control	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Slide x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 1 Luminance key Mix 1 Mix — SDI-IN 1 to 4, DVI-IIN, HDMI 1 to 2/Composite video 1 to 2 SDI-IN 1 to 4, DVI-IIN, HDMI 1 to 2/Composite video 1 to 2 Every A/B bus 1 system Labels, Tally indication, Split-screen (the screen split into 10a only)
December Column Mainframe Duals 30 pin x 1, 15 4:22 past disperse control Deals 9 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse control Deals 50 pin x 1, 15 4:22 past disperse Deals 50 pin x 1, 15 4:22 past disperse Deals 50 pin x 1, 15 4:22 past disperse Deals 50 pin x 1, 15 4:22 past disperse Deals 50 pin x 1, 15 4:22 past disperse Deals 50 pin x 2, 15 4:22 past disperse Deals 50 pin	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Silde x 8 Cut, Mix, Wipe (including DVE) Image effect: PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 1 Luminance key Mix 1 Luminance key Mix 1 SDHIN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHIN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 Every A/B bus Labels, Tally indication, Split-screen (the screen split into 10a only) OSD (several MULTI outputs), WFM, Audio level meter, Embedded audio(SDI, HDMI)
COM	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Side x 8 Cut, Mix, Wipe (including DVE) Image effect PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 1 Luminance key Mix 1 Luminance key Mix 1 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 5, DVH IN, HDMI 1 to 5, SWH IN, SWH
Inter-Eace	TALLY output: D-sub 9 pin x 1, 8 Cross point, Open-collector, Maximum current: Less than 50 mA, Maximum Voltage: 35 VDC GPI: BNC x 1, Make-Contact — CD-ROM (Operating instructions), Power code (3 core cable) Wipe (BASIC1+2) x 37, Wipe (+MULTI) x 16, Wipe (BLIND) x 23, Wipe (MATRIX) x 7, Squeeze (COMP+SINGLE) x 13, 2ch Squeeze (COMP+BOTH) x 8, Side x 8 Cut, Mix, Wipe (including DVE) Image effect PGM/A, PST/B BUS Effect: Mosaic, Defocus, Mono, Time effects, Decay, Paint, Nega, Mirror 1 Linear key, Luminance key, Chroma key, Full key Cut, Mix, Wipe (including DVE) Wipe x 6 1 Luminance key Mix 1 Luminance key Mix 1 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 4, DVH IN, HDMI 1 to 2/Composite video 1 to 2 SDHN 1 to 5, DVH IN, HDMI 1 to 5, SWH IN, SWH

^{*1: 1080/24}PsF and 23.98PsF are not compatible with optional boards AV-HS04 M1, M2, M3, M4, M5, M6, M7, M7D and M8. *2: 1080/24PsF and 23.98PsF are not compatible with optional boards AV-HS04 M1, M2, M3, M4, M5, M6, M7, M7D and M8. *2: 1080/24PsF and 23.98PsF are not compatible with optional boards AV-HS04 M1, M2, M3, M4, M5, M6, M7, M7D and M8. *2: 1080/24PsF and 23.98PsF are not compatible with optional boards AV-HS04 M1, M2, M3, M4, M5, M6, M7, M7D and M8. *2: 1080/24PsF and 23.98PsF are not compatible with optional boards AV-HS04 M1, M2, M3, M4, M5, M6, M7, M7D and M8. *2: 1080/24PsF and 23.98PsF are not compatible with optional boards AV-HS04 M1, M2, M3, M4, M5, M6, M7, M7D and M8. *2: 1080/24PsF and 23.98PsF are not compatible with optional boards AV-HS04 M1, M2, M3, M4, M5, M6 and M7. *3: For information on input/output signals, see page 10, "Input Formats." *4: AUX BUS 1 is compatible with MIX transition. *5: Specifications for IN A1, A2, B1, and B2 depend on the specs of the mounted optional equipment. *6: Maximum 20 channels may be simultaneously displayed on two screens.

^{*7:} May store and recall up to 10 presets (per camera) with current Panasonic pan-tilt systems. *8: May also be used for DSK applications by changing the key layer. *9: Plans call for supporting this function in the future. *10: OSD, MV frames, Labels, Tally indications, Audio Level Meters, and Camera setting information are not shown on SDI-OUT 1. *11: OSD, MV frames, Labels, Tally indications, Audio Level Meters, and Camera setting information for MultiViewer Display are not stored in the Frame Memory.